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STTH60W03C

Turbo 2 ultrafast high voltage rectifier

Datasheet - production data

Features

- Ultrafast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses
- ECOPACK[®]2 compliant component

Description

The STTH60W03C uses ST Turbo 2 300 V technology. It is especially suited to be used for DC/DC and DC/AC converters in secondary stage of MIG/MMA/TIG welding machine. Housed in ST's TO-247, this device offers high power integration for all welding machines and industrial applications.

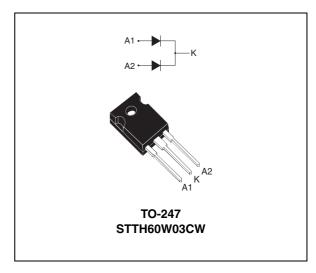


Table 1. Device summary

Symbol	Value
I _{F(AV)}	2 x 30 A
V _{RRM}	300 V
t _{rr} (typ)	25 ns
T _j	175 °C
V _F (typ)	0.94 V

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1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C, unless otherwise specified)

Symbol	Paramete	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage	300	V		
I _{F(RMS)}	RMS forward current	RMS forward current			
1	Average forward current, $\delta = 0.5$	T _c = 110 °C	Per diode	30	Α
'F(AV)	$I_{F(AV)}$ Average forward current, $\delta = 0.5$		Per device	60	^
I _{FSM}	Surge non repetitive forward current	280	Α		
T _{stg}	Storage temperature range	-65 to + 175	° C		
T _j	Maximum operating junction temperature			+ 175	° C

Table 3. Thermal resistance

Symbol	Parameter	Parameter		
D	Junction to case	Per diode	1.5	°C/W
R _{th(j-c)}		Total	0.9	°C/W
R _{th(c)}	Coupling		0.3	°C/W

When diodes 1 and 2 are used simultaneously:

 $Tj_{(diode\ 1)} = P_{(diode\ 1)}\ x\ R_{th(j\text{-}c)}(Per\ diode) + P_{(diode\ 2)}\ x\ R_{th}(c)$

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
ı (1) D	Payaraa laakaga aurrant	T _j = 25 °C	V _R = V _{RRM}			20	μΑ
'R`′	I _R ⁽¹⁾ Reverse leakage current	T _j = 125° C			20	200	
	V _F ⁽²⁾ Forward voltage drop	T _j = 25° C	I _F = 30 A			1.45	
V (2)		T _j = 150 °C			0.94	1.15	V
V _F \ /		T _j = 25° C	I _F = 60 A			1.7	V
		T _j = 150° C			1.18	1.45	

^{1.} Pulse test: tp = 5 ms, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 0.85 \text{ x } I_{F(AV)} + 0.01 I_{F(RMS)}^{2}$$

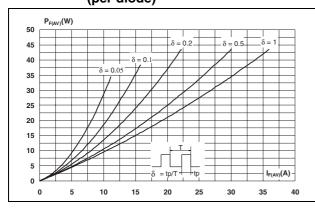
^{2.} Pulse test: $tp = 380 \mu s$, $\delta < 2\%$

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Table 5. Dynamic electrical characteristics

Symbol	Parameter	Test conditions			Тур	Max.	Unit
I _{RM}	Reverse recovery current				7	9	Α
Q _{RR}	Reverse recovery charge	T _j = 125 °C	$I_F = 30 \text{ A}, V_R = 200 \text{ V}$ $dI_F/dt = -200 \text{ A/}\mu\text{s}$		180		nC
S _{factor}	Softness factor	αιρ/αι = -200 Αγμο			0.3		
t _{rr}	Reverse recovery time	T _j = 25 °C	$I_F = 1 \text{ A}, V_R = 30 \text{ V}$ $dI_F/dt = -100 \text{ A/}\mu\text{s}$		25	35	ns
t _{fr}	Forward recovery time	T _i = 25 °C	I _F = 30 A, V _{FR} = 1.5 V			180	ns
V _{FP}	Forward recovery voltage	1j - 25 C	dI _F /dt = 200 A/μs		2.0	3.0	٧

Figure 1. Average forward power dissipation Figure 2. Forward voltage drop versus versus average forward current (per diode) forward current (per diode)



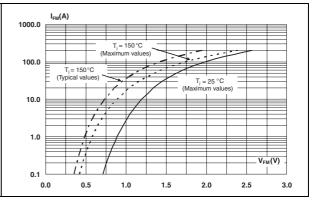
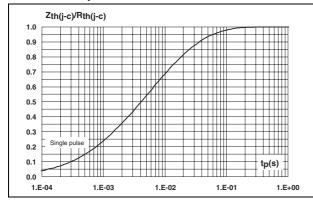
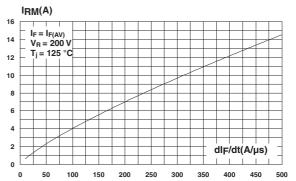


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values, per diode)





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Figure 5. Reverse recovery time versus dl_F/dt Figure 6. Reverse recovery charges versus dl_F/dt (typical values, per diode)

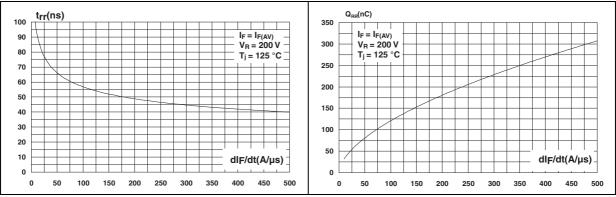
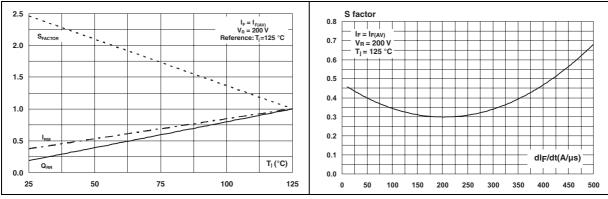


Figure 7. Relative variations of dynamic parameters versus junction temperature

Figure 8. Reverse recovery softness factor versus dl_F/dt (typical values, per diode)



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Figure 9. Forward recovery time versus dl_F/dt Figure 10. Transient peak forward voltage (typical values, per diode)

Transient peak forward voltage versus dl_F/dt (typical values, per diode)

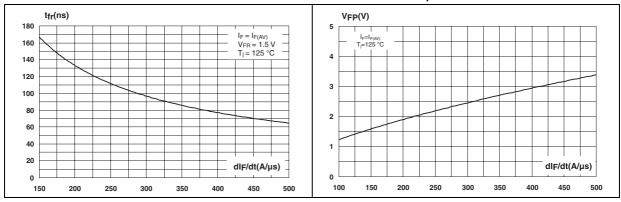
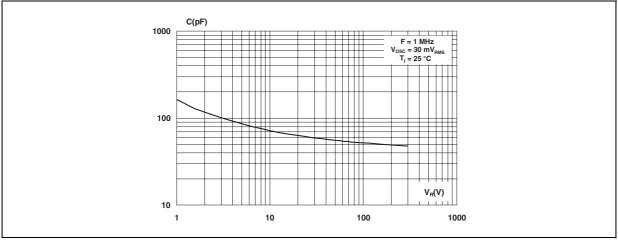


Figure 11. Junction capacitance versus reverse voltage applied (typical values, per diode)

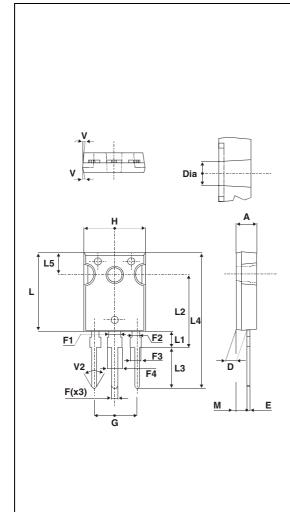


2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N⋅m (1.0 N⋅m maximum)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 6. TO-247 dimensions



	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.85	5.15	0.191	0.203	
D	2.20	2.60	0.086	0.102	
Е	0.40	0.80	0.015	0.031	
F	1.00	1.40	0.039	0.055	
F1	3.00	typ.	0.118	3 typ.	
F2	2.00	typ.	0.078	3 typ.	
F3	2.00 2.40		0.078	0.094	
F4	3.00	3.40	0.118	0.133	
G	10.90	O typ.	0.429 typ.		
Н	15.45	15.75	0.608	0.620	
L	19.85	20.15	0.781	0.793	
L1	3.70	4.30	0.145	0.169	
L2	18.50	0 typ.	0.728	3 typ.	
L3	14.20	14.80	0.559	0.582	
L4	34.60	0 typ.	1.362	2 typ.	
L5	5.50 typ.		0.21	6 typ.	
М	2.00	3.00	0.078	0.118	
V	5° typ.		5° typ.		
V2	60°	typ.	60°	typ.	
Dia.	3.55	3.65	0.139	0.143	

3 Ordering information

Table 7. Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTH60W03CW	STTH60W03CW	TO-247	4.46 g	50	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
07-June-2012	1	First issue.

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